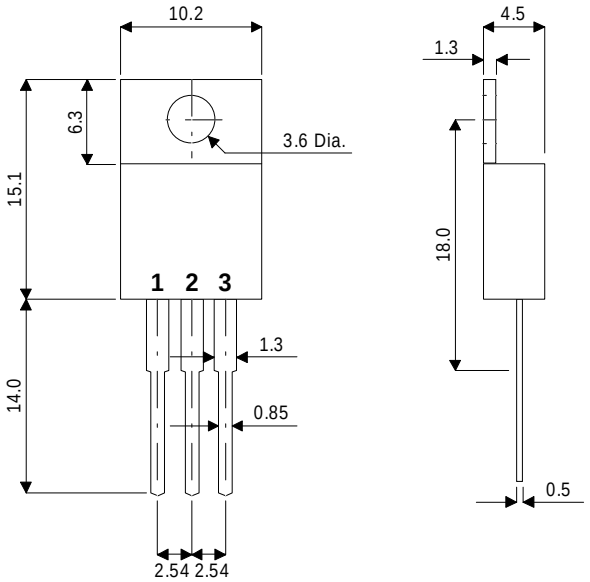
BUL57A

ADVANCED DISTRIBUTED BASE DESIGN HIGH VOLTAGE HIGH SPEED NPN SILICON POWER TRANSISTOR

MECHANICAL DATA
Dimensions in mm



TO220

Pin 1 – Base Pin 2 – Collector Pin 3 – Emitter

Designed for use in electronic ballast applications

- **SEMEFAB DESIGNED AND DIFFUSED DIE**
- **HIGH VOLTAGE**
- **FAST SWITCHING**
- **HIGH ENERGY RATING**

FEATURES

- **Multi–base for efficient energy distribution across the chip resulting in significantly improved switching and energy ratings across full temperature range.**
- **Ion implant and high accuracy masking for tight control of characteristics from batch to batch.**
- **Triple Guard Rings for improved control of high voltages.**

ABSOLUTE MAXIMUM RATINGS (T_{case} = 25°C unless otherwise stated)

V_{CBO}	Collector – Base Voltage(I_E=0)	200V
V_{CEO}	Collector – Emitter Voltage (I_B = 0)	70V
V_{EBO}	Emitter – Base Voltage (I_C = 0)	10V
I_C	Continuous Collector Current	22A
$I_{C(PK)}$	Peak Collector Current	32A
I_B	Base Current	6A
P_{tot}	Total Dissipation at T_{case} = 25°C	80W
T_{stg}	Operating and Storage Temperature Range	–55 to +150°C

ELECTRICAL CHARACTERISTICS (T_{case} = 25°C unless otherwise stated)

	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
	ELECTRICAL CHARACTERISTICS						
$V_{CEO(sus)}$	Collector – Emitter Sustaining Voltage	I_C = 10mA		70			V
$V_{(BR)CBO}$	Collector – Base Breakdown Voltage	I_C = 1mA		200			V
$V_{(BR)EBO}$	Emitter – Base Breakdown Voltage	I_E = 1mA		10			V
I_{CBO}	Collector – Base Cut–Off Current	V_{CB} = 200V				10	µA
			T_C = 125°C			100	µA
I_{CEO}	Collector – Emitter Cut–Off Current	I_B = 0	V_{CE} = 60V			100	µA
I_{EBO}	Emitter Cut–Off Current	V_{EB} = 9V				10	µA
		I_C = 0	T_C = 125°C			100	µA
h_{FE*}	DC Current Gain	I_C = 0.3A	V_{CE} = 4V	30		90	—
		I_C = 5A	V_{CE} = 4V	25		60	—
		I_C = 15A	V_{CE} = 4V	20		50	—
			T_C = 125°C				—
$V_{CE(sat)*}$	Collector – Emitter Saturation Voltage	I_C = 1A	I_B = 0.1A		0.1	0.2	V
		I_C = 5A	I_B = 0.5A		0.3	0.6	V
		I_C = 15A	I_B = 1.5A		1.0	1.5	V
$V_{BE(sat)*}$	Base – Emitter Saturation Voltage	I_C = 5A	I_B = 0.5A			1.2	V
		I_C = 15A	I_B = 1.5A			1.4	V
	DYNAMIC CHARACTERISTICS						
f_t	Transition Frequency	I_C = 0.2A	V_{CE} = 4V		20		MHz
C_{ob}	Output Capacitance	V_{CB} = 10V	f = 1MHz				pF

* Pulse test t_p = 300µs , δ < 2%